

TPS23751EVM-104 EVM: Evaluation Module for TPS23751

This User's Guide describes the evaluation module (EVM) for the TPS23751 (TPS23751EVM-104). TPS23751 is a type 2 Power over Ethernet (PoE) powered device (PD) controller and integrated current-mode DC/DC controller. TPS23751 is optimized specifically for applications requiring high efficiency over a wide load range.

Contents

| | | |
|-----|---|----|
| 1 | Introduction | 2 |
| 1.1 | Features | 2 |
| 1.2 | Applications | 2 |
| 2 | Electrical Specifications at 25°C | 2 |
| 3 | Description | 3 |
| 4 | Schematic | 4 |
| 5 | General Configuration and Description | 6 |
| 5.1 | Physical Access | 6 |
| 5.2 | Test Setup | 7 |
| 6 | TPS23751EVM-104 Performance Data | 7 |
| 6.1 | Efficiency | 7 |
| 7 | EVM Assembly Drawings and Layout Guidelines | 9 |
| 7.1 | PCB Drawings | 9 |
| 7.2 | Layout Guidelines | 12 |
| 7.3 | EMI Containment | 13 |
| 8 | Bill of Materials | 14 |

List of Figures

| | | |
|----|--|----|
| 1 | TPS23751EVM-104 Schematic (1 of 2)..... | 4 |
| 2 | TPS23751EVM-104 Schematic (2 of 2)..... | 5 |
| 3 | Typical TPS23751EVM-104 Test Setup | 7 |
| 4 | TPS23751EVM-104 PoE End-to-End Efficiency | 8 |
| 5 | TPS23751EVM-104 DC/DC Converter Efficiency | 8 |
| 6 | TPS23751EVM-104 DC/DC Converter Light-Load Efficiency..... | 8 |
| 7 | Top-Side Placement | 9 |
| 8 | Top-Side Routing | 9 |
| 9 | Layer Two Routing | 10 |
| 10 | Layer Three Routing | 10 |
| 11 | Bottom-Side Routing | 11 |
| 12 | Bottom-Side Placement..... | 11 |

List of Tables

| | | |
|---|--|----|
| 1 | TPS23751EVM-104 Electrical and Performance Specifications..... | 2 |
| 2 | Connector Functionality | 6 |
| 3 | Test Points and Indicators | 6 |
| 4 | Jumpers | 6 |
| 5 | TPS23751EVM-104 Bill of Materials | 14 |

1 Introduction

The TPS23751EVM allows reference circuit evaluation of the TI TPS23751 PD controller AND DC/DC controller.

1.1 Features

- Efficient synchronous flyback design including enhanced light load operation (with synchronous rectifier disable and variable frequency operation).
- 24-V and 48-V adapter input capability
- Gigabit Ethernet passthrough interface
- IEEE 802.3at type-2 hardware classification with secondary-side status flag (T2P) and LED
- Robust 100-V, 0.5- Ω internal hotswap MOSFET
- 5-V, 4.5-A, 22.5-W dc output

1.2 Applications

- IEEE 802.3at-compliant devices
- Video and VoIP telephones
- Multiband access points
- Security cameras
- Pico-base stations

2 Electrical Specifications at 25°C

Table 1. TPS23751EVM-104 Electrical and Performance Specifications

| Parameter | Condition | Min | Typ | Max | Unit |
|-------------------------------------|--|------------|------|------|------|
| POWER INTERFACE | | | | | |
| Input Voltage | Applied to the power pins of connectors J1 or J3 | 0 | 57 | | V |
| Input UVLO, POE input J1 | Rising input voltage | | 40 | | V |
| | Falling input voltage | 30 | | | |
| Input UVLO, adapter J3 | Rising input voltage | | 37 | | V |
| Detection voltage | At device terminals | 1.4 | 10.1 | | V |
| Classification voltage | At device terminals | 11.9 | 23.0 | | V |
| Classification current | $R_{CLASS} = 63.4 \Omega$ | 38 | 42 | | mA |
| Inrush current-limit | | 100 | 180 | | mA |
| Operating current-limit | | 850 | 1200 | | mA |
| DC/DC CONVERTER | | | | | |
| Output voltage | $21.6 \text{ V} \leq V_{IN} \leq 57 \text{ V}$, $I_{LOAD} \leq I_{LOAD}(\text{max})$ | 5-V output | 4.85 | 5.00 | 5.15 |
| Output current | $21.6 \text{ V} \leq V_{IN} \leq 57 \text{ V}$ | 5-V output | | 4.5 | A |
| Output ripple voltage, peak-to-peak | $V_{IN} = 44 \text{ V}$, $I_{LOAD} = 4.5 \text{ A}$ | 5-V output | 30 | | mV |
| Efficiency, DC/DC converter | $V_{IN} = 54 \text{ V}$, $I_{LOAD} = 4.5 \text{ A}$ | 5-V output | 90 | | % |
| Efficiency, end-to-end | $V_{IN} = 54 \text{ V}$, $I_{LOAD} = 4.5 \text{ A}$ | 5-V output | 87.5 | | % |
| Switching frequency | PWM mode | | 225 | 275 | kHz |

3 Description

TPS23751EVM-104 enables full evaluation of the TPS23751 device. Refer to the schematic shown in [Figure 1](#) and [Figure 2](#). Ethernet power is applied from J1 to T1 and is dropped to the diode bridges (D2/D3/D7/D8 or D4/D5/D9/D10) from the T1 center taps. The series R-C circuits from each center tap help balance the Ethernet cable impedance and are critical for ESD and EMI/EMC performance. These circuits are terminated at TP22 (EGND) through the high-voltage capacitor, C11. At the output of the diode bridges is the EMI/EMC filter and transient protection for the TPS23751.

Input power can also be applied at J3 from a dc source. EMI/EMC filtering is provided at this connector as well and diode D1 provides reverse voltage protection. R4 and R6 provide a threshold for the TPS23751 APD pin so that the TPS23751 internal MOSFET is disabled when the voltage at J3 is above approximately 18 V. This ensures that the adapter has priority over the power-sourcing equipment (PSE) source.

Below the PoE diode bridges in [Figure 1](#) is the TPS23751 type 2 PoE source detection circuit. The U1 circuit provides indication of when an adapter or type 2 PoE source is present.

The TPS23751 (U2) PD and dc/dc converter circuitry is shown in [Figure 2](#). R39 provides the detection signature and R19 provides the classification (class 4) signature. To the right of U2 is the switched side of the PD controller. The TPS23751 RTN pin provides inrush limited turn on and charge of the bulk capacitor, C20. During inrush, the TPS23751 dc/dc controller is disabled.

The dc/dc converter is a self-driven synchronous, isolated flyback topology. The flyback converter operates in either variable frequency (VFO) or pulse-width modulated (PWM) modes depending on output loading to boost wide-load range efficiency. The primary (Q3) switching MOSFET is driven from the U2 GATE pin and the secondary (Q4) switching MOSFET is driven from a drive winding on T2. MOSFET gate-drive buffering and phasing is provided by Q6/D15/R22 (primary) and Q5/D14/D17//R21/C27/R27 (secondary), respectively. In addition to Q4, D20 provides secondary-side rectification when the converter is in VFO mode. R18/D13/C24/C25 form the auxiliary 12-V output for the U2 DC/DC controller and D12/R14/C23 provide peak voltage-clamp protection for Q3.

Output voltage feedback is provided with the U4 and associated error amplifier (U5) circuitry. R33 provides a means for error injection to measure the frequency response of the converter. This feedback circuit drives the U2 CTL pin which provides a voltage proportional to the output load current. The voltage on the CTL pin is also used to detect the desired mode transition point by comparing this with the voltage on the SRT pin (set by R24 and R28). Q8 and R40 can provide SRT pin hysteresis, if required by the application. As output load current decreases, the CTL pin voltage decreases. When CTL crosses the transition point (to go into VFO mode), the converter disables Q4 and allows D20 to rectify. This is accomplished with the U2 SRD pin, U3, and Q2/Q7. In VFO mode, Q7-A and Q7-B are ON and Q2 is OFF. This effectively extinguishes the Q4 gate drive allowing D20 to rectify. When output load increases, the converter goes back to PWM mode and allows Q4 to provide rectification.

4 Schematic

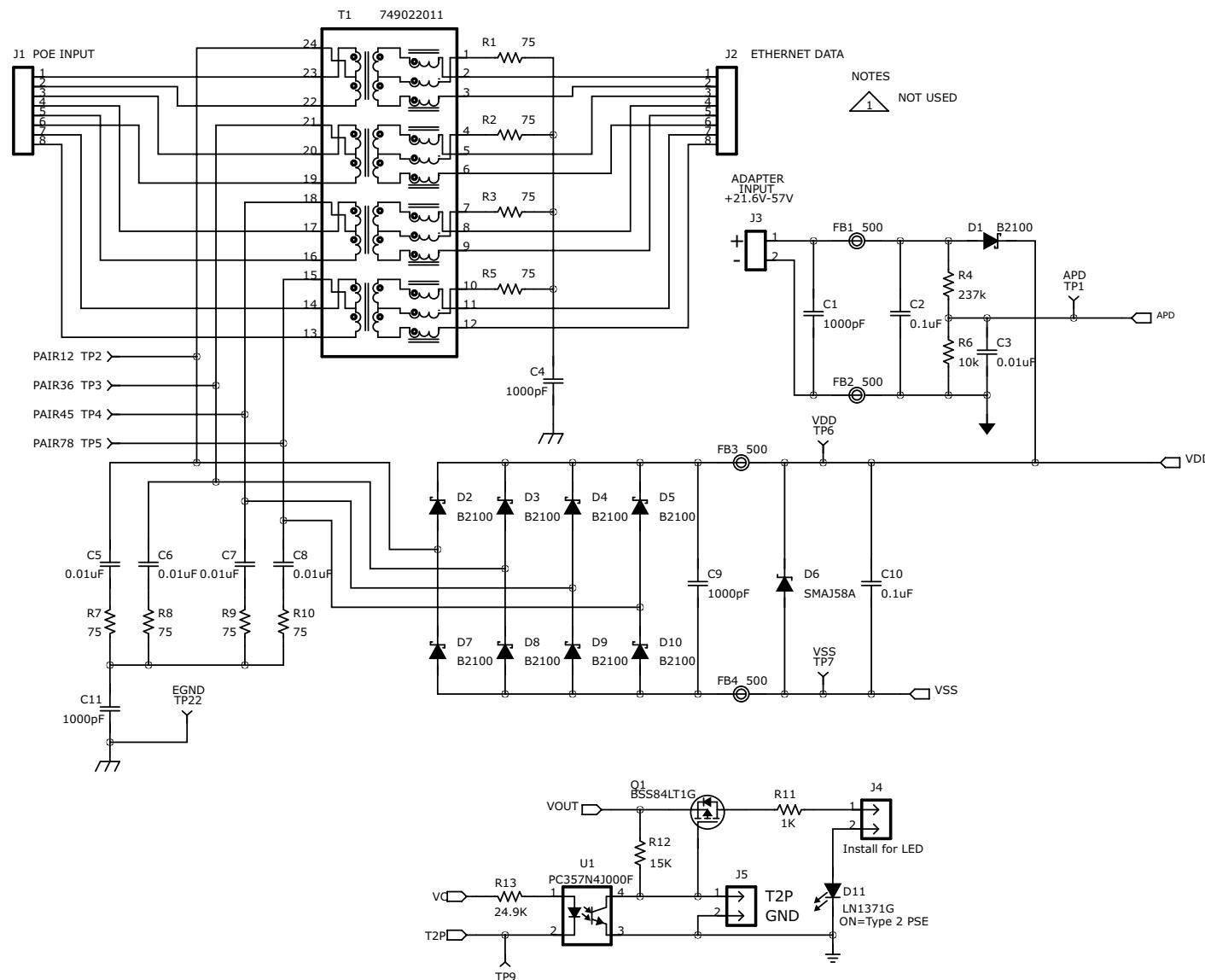


Figure 1. TPS23751EVM-104 Schematic (1 of 2)

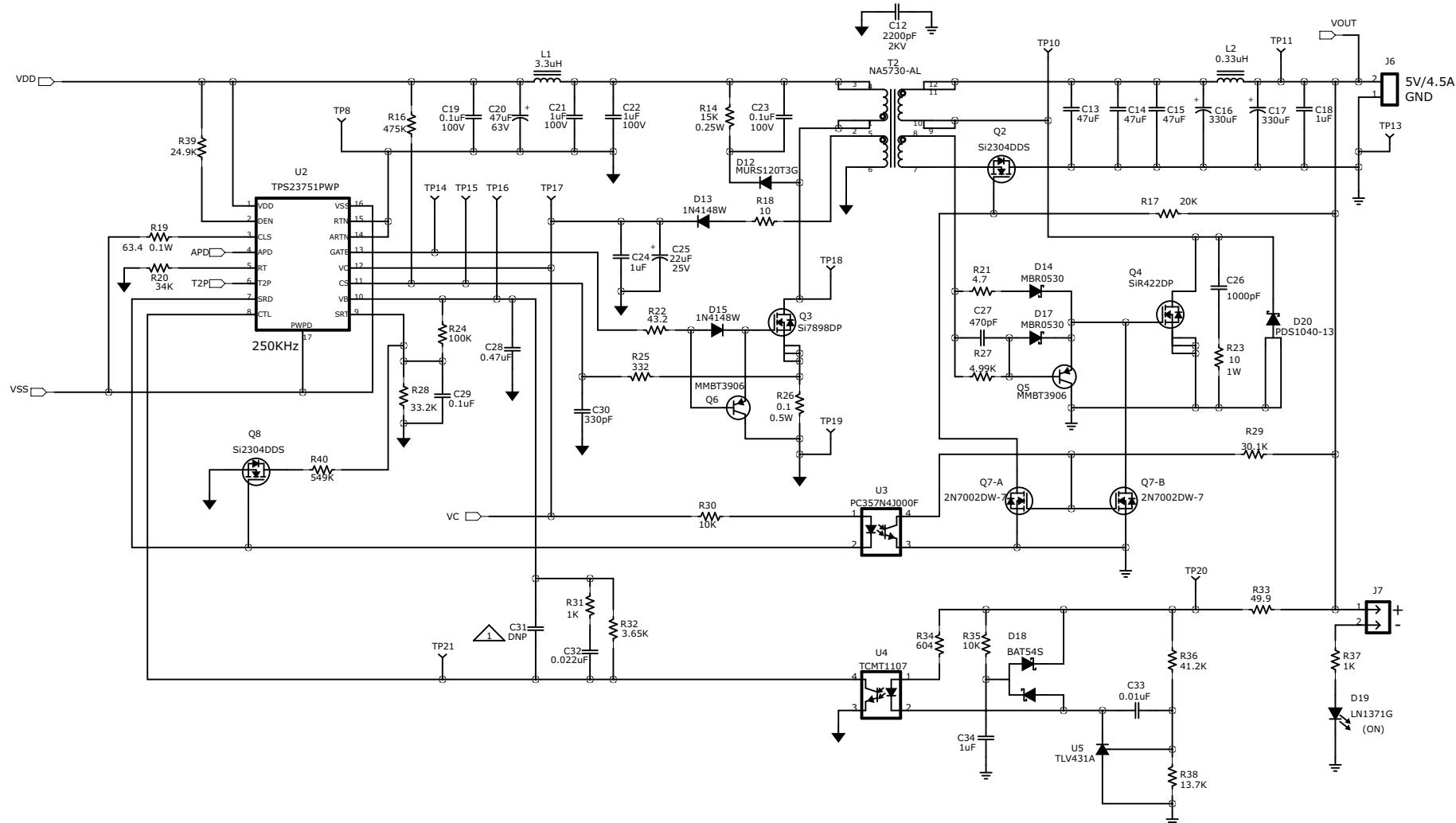


Figure 2. TPS23751EVM-104 Schematic (2 of 2)

5 General Configuration and Description

5.1 Physical Access

[Table 2](#) lists the EVM connector functionality, [Table 3](#) describes the test point availability, and describes the jumper functionality.

Table 2. Connector Functionality

| Connector | Label | Description |
|-------------|----------|---|
| J1 | PWR+DATA | POE input. Connect to PSE power and data source. |
| J2 | DATA | Ethernet data passthrough. Connect to downstream Ethernet device. |
| J5 | T2P | Low voltage on pin 1 with respect to pin 2 indicates that a type-2 PSE or an adapter is present |
| J6 | OUTPUT | Output connector to load |
| D11 (Green) | T2P | T2P (type-2 PSE) LED. When ON this indicates that a type-2 PSE or an adapter is present. |
| D19 (Green) | OUTPUT | TPS23751 output powered |

Table 3. Test Points and Indicators

| Test Point | Color | Label | Description |
|------------|-------|--------|--|
| TP2 | RED | PAIR12 | Data pair from pins 1 and 2 of J1 |
| TP3 | ORG | PAIR36 | Data pair from pins 3 and 6 of J1 |
| TP4 | RED | PAIR45 | Spare pair from pins 4 and 5 of J1 |
| TP5 | ORG | PAIR78 | Spare pair from pins 7 and 8 of J1 |
| TP6 | RED | VDD | High-side output from bridge |
| TP7 | BLK | VSS | Low-side output from bridge |
| TP11 | RED | VOUT | Converter output voltage with respect to TP13 |
| TP8, TP19 | BLK | PWRGND | Switched low side from TPS23751 |
| TP10 | ORG | SDRN | Secondary-side switching waveform |
| TP16 | RED | VB | TPS23751 5-V bias voltage |
| TP17 | RED | VC | TPS23751 12-V auxiliary input voltage |
| TP13 | BLK | GND | Converter output ground with respect to TP8 |
| TP14 | WHT | GATE | TPS23751 gate-drive output |
| TP15 | WHT | CS | TPS23751 CS pin input |
| TP18 | ORG | PDRN | Primary-side switching waveform |
| TP20 | ORG | LOOP | Feedback loop injection point. Use with TP11 and TP13. |
| TP21 | WHT | CTL | CTL pin input to TPS23751 |
| TP22 | SM | EGND | Earth or chassis ground point |

Table 4. Jumpers

| Jumper | Label | Description |
|--------|-------|--|
| J4 | J4 | D11 LED bias jumper. Install to enable T2P LED. Shunt may be removed when making efficiency measurements. |
| J7 | J7 | D19 LED bias jumper. Install to enable OUTPUT LED. Shunt may be removed when making efficiency measurements. |

5.2 Test Setup

Figure 3 shows a typical test setup for the EVM. Connect J1 to the PSE. Power for the Ethernet device is available at J6 and the passthrough Ethernet data is available at J2.

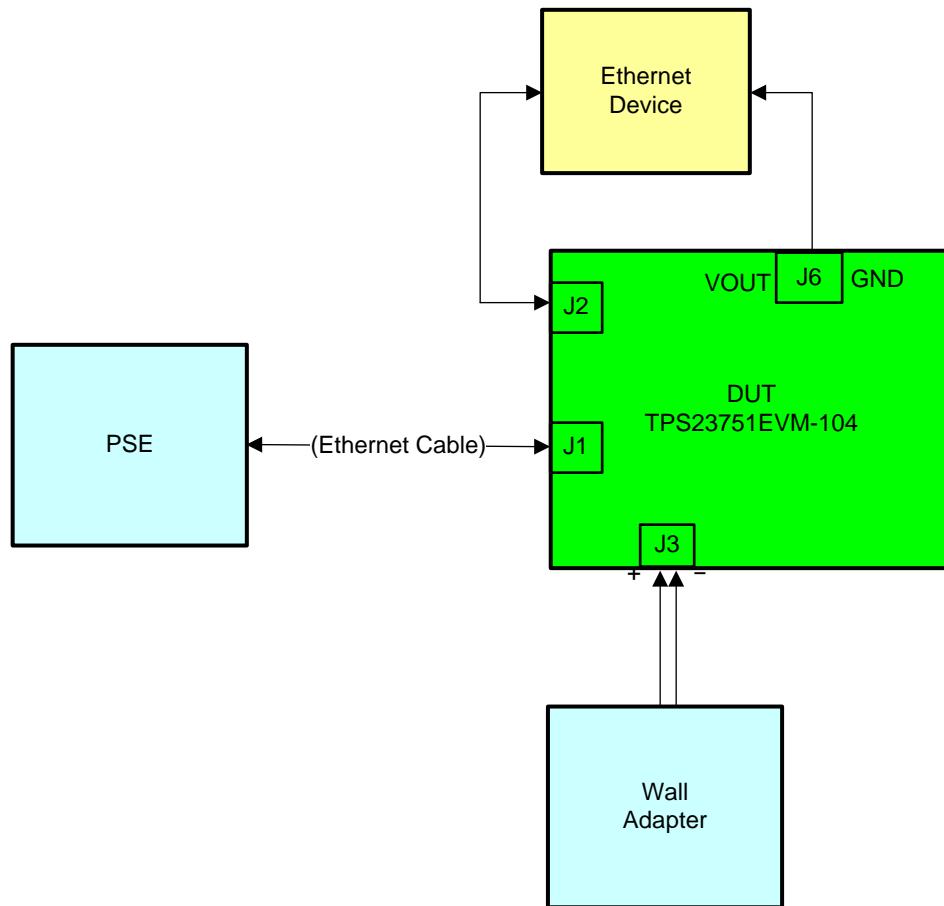


Figure 3. Typical TPS23751EVM-104 Test Setup

6 TPS23751EVM-104 Performance Data

6.1 Efficiency

Figure 4 through Figure 6 illustrate the efficiency of the EVM. In Figure 4, the efficiency is measured between the J1 input interface and J6 output connector while Figure 5 and Figure 6 are measured between TP6/TP7 and J6 in order to exclude the diode bridge and Ethernet transformer losses. Figure 6 demonstrates the light-load efficiency improvement provided by VFO mode.

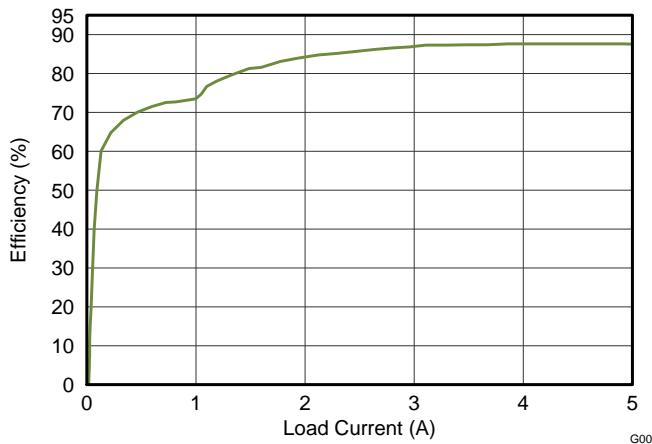


Figure 4. TPS23751EVM-104 PoE End-to-End Efficiency

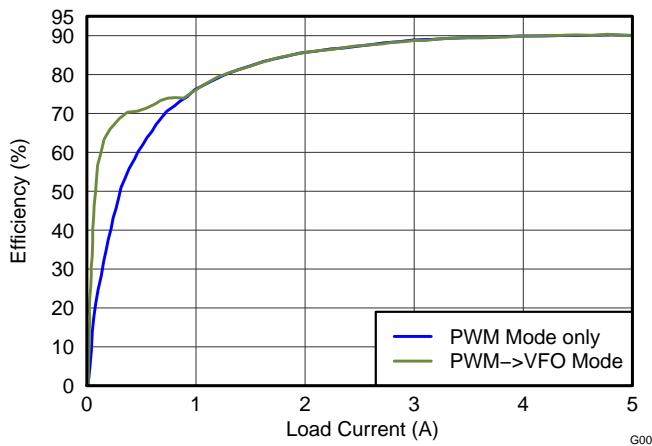


Figure 5. TPS23751EVM-104 DC/DC Converter Efficiency

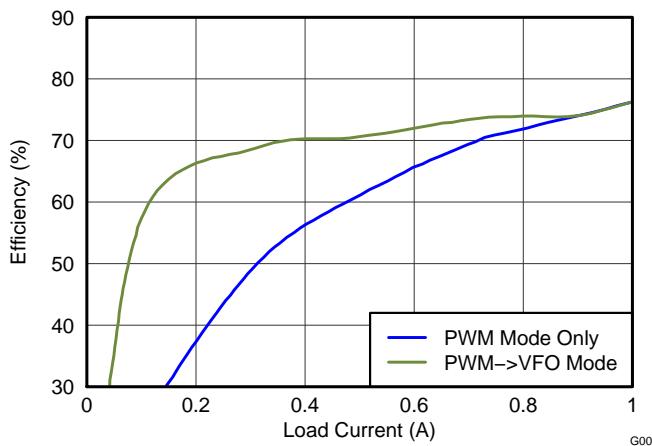


Figure 6. TPS23751EVM-104 DC/DC Converter Light-Load Efficiency

7 EVM Assembly Drawings and Layout Guidelines

7.1 PCB Drawings

Figure 7 through Figure 12 show component placement and layout.

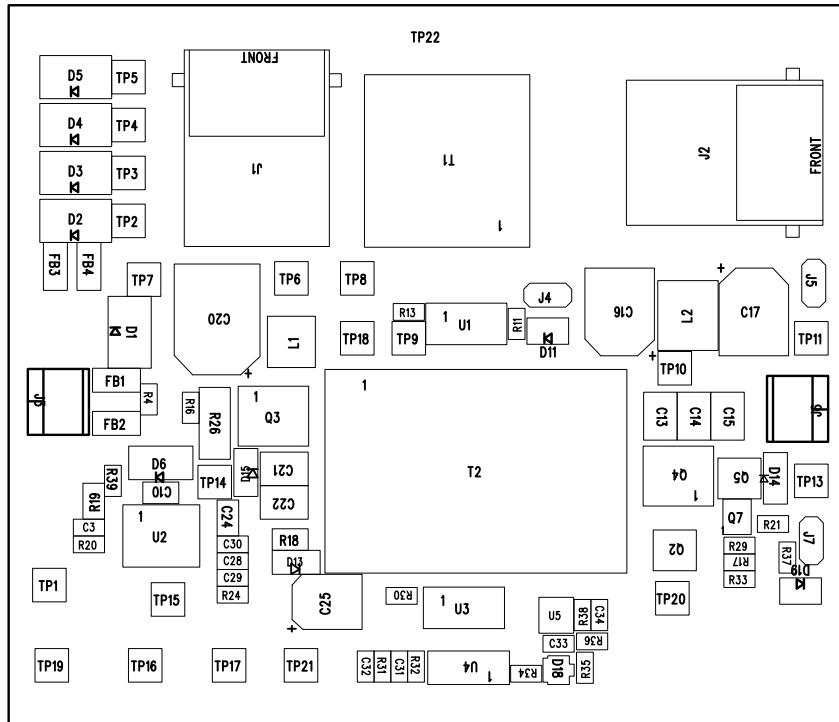


Figure 7. Top-Side Placement

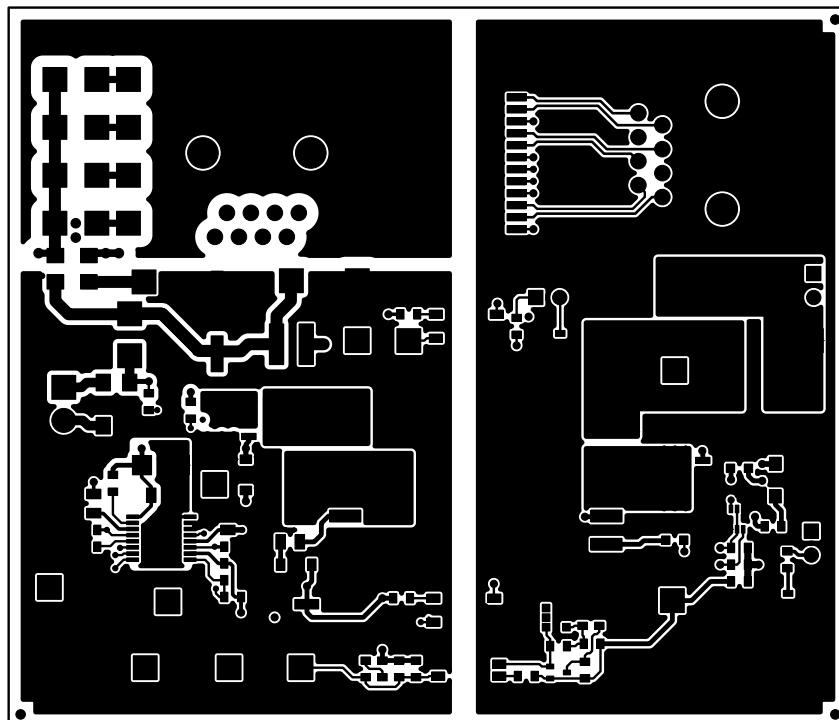


Figure 8. Top-Side Routing

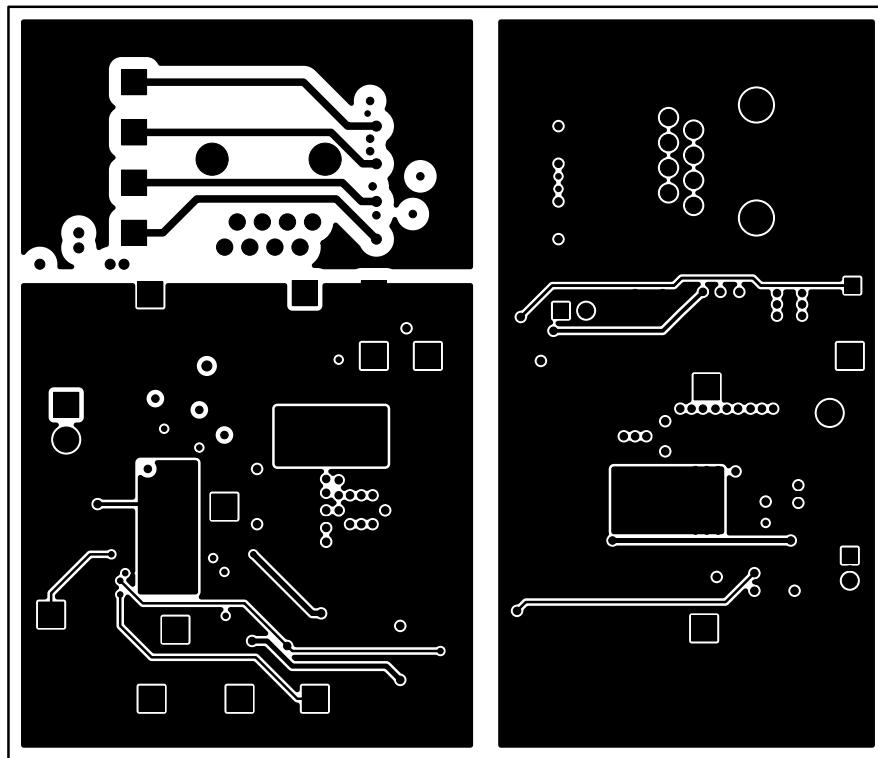


Figure 9. Layer Two Routing

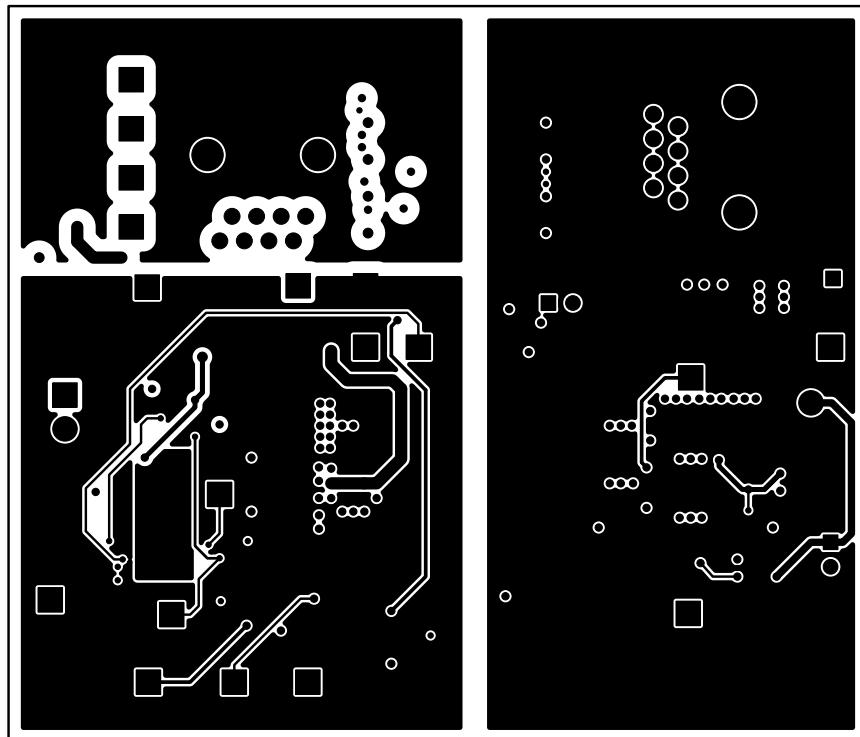


Figure 10. Layer Three Routing

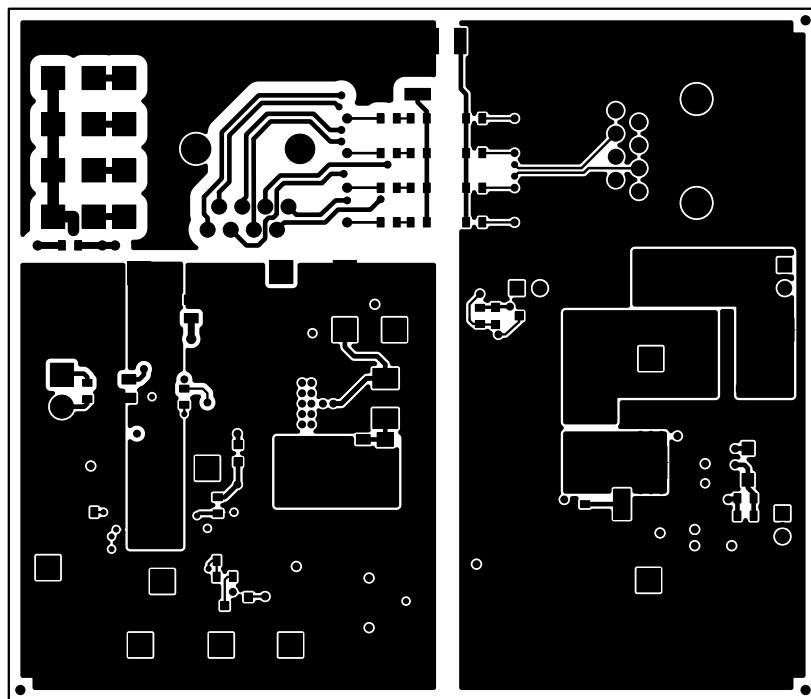


Figure 11. Bottom-Side Routing

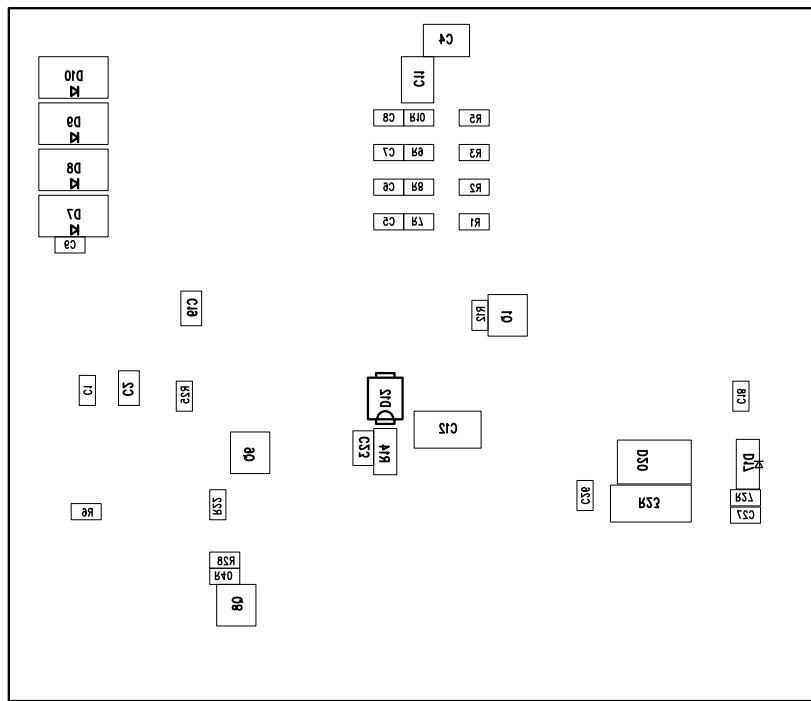


Figure 12. Bottom-Side Placement

7.2 Layout Guidelines

The layout of the PoE front end should follow power and EMI/ESD best-practice guidelines. A basic set of recommendations include:

- Parts placement must be driven by power flow in a point-to-point manner; RJ-45, Ethernet transformer, diode bridges, TVS and 0.1- μ F capacitor, and TPS23751 converter input bulk capacitor.
- Make all leads as short as possible with wide power traces and paired signal and return.
- No crossovers of signals from one part of the flow to another are allowed.
- Spacing consistent with safety standards like IEC60950 must be observed between the 48-V input voltage rails and between the input and an isolated converter output.
- Place the TPS23751 over split, local ground planes referenced to V_{SS} for the PoE input and to COM/RTN for the converter. Whereas the PoE side may operate without a ground plane, the converter side must have one. Do not place logic ground and power layers under the Ethernet input or the converter primary side.
- Use large copper fills and traces on SMT power-dissipating devices, and use wide traces or overlay copper fills in the power path.

The DC/DC Converter layout benefits from basic rules such as:

- Pair signals to reduce emissions and noise, especially the paths that carry high-current pulses which include the power semiconductors and magnetics.
- Minimize trace length of high current, power semiconductors, and magnetic components.
- Where possible, use vertical pairing
- Use the ground plane for the switching currents carefully.
- Keep the high-current and high-voltage switching away from low-level sensing circuits including those outside the power supply.
- Proper spacing around the high-voltage sections of the converter

7.3 EMI Containment

- Use compact loops for dv/dt and di/dt circuit paths (power loops and gate drives)
- Use minimal, yet thermally adequate, copper areas for heat sinking of components tied to switching nodes (minimize exposed radiating surface).
- Use copper ground planes (possible stitching) and top-layer copper floods (surround circuitry with ground floods)
- Use a 4-layer PCB, if economically feasible (for better grounding)
- Minimize the amount of copper area associated with input traces (to minimize radiated pickup)
- Hide copper associated with switching nodes under shielded magnetics, where possible
- Heat sink the *quiet side* of components instead of the *switching side*, where possible (like the output side of inductor)
- Use Bob Smith terminations, Bob Smith EFT capacitor, and Bob Smith plane
- Use Bob Smith plane as ground shield on input side of PCB (creating a phantom or literal earth ground)
- Use LC filter at DC/DC input
- Dampen high-frequency ringing on all switching nodes, if present (allow for possible snubbers)
- Control rise times with gate-drive resistors and possibly snubbers
- Switching frequency considerations
- Use of EMI bridge capacitor across isolation boundary (isolated topologies)
- Observe the polarity dot on inductors (embed noisy end)
- Use of ferrite beads on input (allow for possible use of beads or 0- Ω resistors)
- Maintain physical separation between input-related circuitry and power circuitry (use ferrite beads as boundary line)
- Balance efficiency versus acceptable noise margin
- Possible use of common-mode inductors
- Possible use of integrated RJ-45 jacks (shielded with internal transformer and Bob Smith terminations)
- End-product enclosure considerations (shielding)

8 Bill of Materials

Table 5. TPS23751EVM-104 Bill of Materials

| Count | REFDES | Value | Description | Size | Part Number | Supplier |
|-------|----------------|-----------|--|------------------|-----------------------------|--------------------|
| 3 | C1 C9 C26 | 1000 pF | Capacitor, ceramic, 100 V, X7R, 10% | 603 | STD | STD |
| 1 | C12 | 2200 pF | Capacitor, ceramic, 2 kV, X7R, 15% | 1812 | Std | Std |
| 3 | C13-15 | 47 µF | Capacitor, ceramic, 10 V, X5R, 15% | 1210 | Std | Std |
| 2 | C16-17 | 330 µF | Capacitor, Aluminum, 6.3 V, 20% | 0.260 x 0.276 in | EEE-FK0J331XP | Panasonic |
| 2 | C18 C34 | 1 µF | Capacitor, ceramic, 16 V, X7R, 10% | 603 | STD | Std |
| 4 | C2 C10 C19 C23 | 0.1 µF | Capacitor, ceramic, 100 V, X7R, 10% | 805 | STD | STD |
| 1 | C20 | 47 µF | Capacitor, Aluminum, 63 V, ±20% | 0.328 x 0.390 in | EEE-FK1J470P | Panasonic |
| 2 | C21-22 | 1 µF | Capacitor, ceramic, 100 V, X7R, 10% | 1210 | Std | STD |
| 1 | C24 | 1 µF | Capacitor, ceramic, 25 V, X7R, 10% | 805 | STD | Std |
| 1 | C25 | 22 µF | Capacitor, Aluminum, 25 V, 20% | 5 x 5.8 mm | EEE-FK1E220R | Panasonic |
| 1 | C27 | 470 pF | Capacitor, ceramic, 16 V, X7R, 10% | 603 | STD | Std |
| 1 | C28 | 0.47 µF | Capacitor, ceramic, 16 V, X7R, 10% | 603 | STD | Std |
| 1 | C29 | 0.1 µF | Capacitor, ceramic, 16 V, X7R, 10% | 603 | STD | Std |
| 6 | C3 C5-8 C33 | 0.01 µF | Capacitor, ceramic, 100 V, X7R, 10% | 603 | STD | STD |
| 1 | C30 | 330 pF | Capacitor, ceramic, 50 V, C0G, 10% | 603 | STD | Std |
| 0 | C31 | DNP | Capacitor, ceramic, 50 V, X7R, 10% | 603 | STD | Std |
| 1 | C32 | 0.022 µF | Capacitor, ceramic, 50 V, X7R, 10% | 603 | STD | Std |
| 2 | C4 C11 | 1000 pF | Capacitor, ceramic, 2 kV, X7R, 15% | 1210 | Std | STD |
| 2 | D11 D19 | LN1371G | Diode, LED, green, 10 mA, 2.6 mcd | 0.114 x 0.049 in | LN1371G | Panasonic |
| 1 | D12 | MURS120T3 | Diode, ultrafast rectifier, 1 A, 200 V | SMB | MURS120T3G | On Semi |
| 2 | D13 D15 | 1N4148W | Diode, signal, 300 mA, 75 V, 350 mW | SOD-123 | 1N4148W-7-F | Diodes |
| 2 | D14 D17 | MBR0530 | Diode, Schottky, 0.5 A, 30 V | SOD-123 | MBR0530T1G | On Semi |
| 9 | D1-5 D7-10 | B2100 | Diode, Schottky, 2 A, 100 V | SMB | B2100-13-F | STD |
| 1 | D20 | PDS1040 | Diode, Schottky, 10 A, 40 V | Power DI 5 | PDS1040-13 | Diodes, Inc |
| 1 | D18 | BAT54S | Diode, dual Schottky, 200 mA, 30 V | SOT323 | BAT54SWT1G | On Semi |
| 1 | D6 | SMAJ58A | Diode, TVS, 58 V, 1 W | SMA | SMAJ58A-13-F | Diodes |
| 4 | FB1-4 | 500 | Bead, ferrite, 2000 mA, 60 mΩ | 1206 | MI1206L501R-10 | Steward |
| 2 | J1-2 | 5520252-4 | Connector, jack, modular, 8 POS | 0.705 x 0.820 in | 5520252-4 | AMP |
| 2 | J3 J6 | ED555/2DS | Terminal block, 2-pin, 6 A, 3.5 mm | 0.27 x 0.25 in | ED555/2DS | OST |
| 3 | J7 J4 J5 | PEC02SAAN | Header, male 2-pin, 100-mil spacing | 0.100 in x 2 | PEC02SAAN | Sullins |
| 1 | L1 | 3.3 µH | Inductor, SMT, 1.9 A, 80 mΩ | 4 x 4 mm | LPS4018-332ML or 7440690033 | Coilcraft or Wurth |
| 1 | L2 | 0.33 µH | Inductor, SMT, 19.2 A, 3.52 mΩ | 5.3 x 5.5 mm | XAL5030-331ME or 744305033 | Coilcraft or Wurth |
| 1 | Q1 | BSS84 | MOSFET, Pch, -50 V, -0.13 A, 10 Ω | SOT23 | BSS84LT1G | Infineon |
| 2 | Q2 Q8 | Si2304DDS | MOSFET, NChannel, 30 V, 3.6 A, 60 mΩ | SOT23 | Si2304DDS-T1-GE3 | Vishay |
| 1 | Q3 | Si7898DP | MOSFET, NChannel, 150 V, 4.8 A, 85 mΩ | PWRPAK S0-8 | Si7898DP-T1-E3 | Vishay |
| 1 | Q4 | SiR422DP | MOSFET, NChannel, 40 V, 40 A, 6.6 mΩ | PWRPAK S0-8 | SiR422DP-T1-GE3 | Vishay |
| 2 | Q5 Q6 | MMBT3906 | Trans, PNP, 40 V, 200 mA, 225 mW | SOT23 | MMBT3906LT1G | On Semi |

Table 5. TPS23751EVM-104 Bill of Materials (continued)

| Count | REFDES | Value | Description | Size | Part Number | Supplier |
|-------|--------------------------|--------------|---|------------------|--------------|-----------|
| 1 | Q7 | 2N7002DW-7 | MOSFET, Dual N-ch, 60 V, 115 mA | SOT363 | 2N7002DW-7-F | Diodes |
| 3 | R11 R31 R37 | 1 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R12 | 15 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 2 | R13 R39 | 24.9 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 8 | R1-3 R5 R7-10 | 75 Ω | Resistor, chip, 1/16W, 1% | 603 | STD | STD |
| 1 | R14 | 15 kΩ | Resistor, chip, 1/4W, 5% | 1206 | Std | Std |
| 1 | R16 | 475 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R17 | 20 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R18 | 10 Ω | Resistor, chip, 1/10W, 5% | 805 | STD | STD |
| 1 | R19 | 63.4 Ω | Resistor, chip, 1/10W, 1% | 805 | Std | Std |
| 1 | R20 | 34 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R21 | 4.7 Ω | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R22 | 43.2 Ω | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R23 | 10 Ω | Resistor, chip, 1W, 5% | 2512 | Std | Std |
| 1 | R24 | 100 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R25 | 332 Ω | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R26 | 0.1 Ω | Resistor, chip, 1/2W, 1% | 2010 | Std | Std |
| 1 | R27 | 4.99 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R28 | 33.2 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R29 | 30.1 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R32 | 3.65 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R33 | 49.9 Ω | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R34 | 604 Ω | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R36 | 41.2 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R38 | 13.7 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | R4 | 237 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | STD |
| 1 | R40 | 549 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 3 | R6 R30 R35 | 10 kΩ | Resistor, chip, 1/16W, 1% | 603 | STD | Std |
| 1 | T1 | 749022011 | Transformer, PoE plus gigabit transformer modules | S024 | 749022011 | Wurth |
| 1 | T2 | NA5730-AL | Transformer, SMT flyback for PoE/PD, 22 W, 5 V, 4.5 A | 20357 x 30 mm | NA5730-AL | Coilcraft |
| 5 | TP1 TP9 TP14-15 TP21 | 5012 | Test point, white, thru hole | 0.125 x 0.125 in | 5012 | Keystone |
| 6 | TP2 TP4 TP6 TP11 TP16-17 | 5010 | Test point, red, thru hole | 0.125 x 0.125 in | 5010 | Keystone |
| 1 | TP22 | 5016 | Test point, SM, 0.150 x 0.090 | 0.185 x 0.135 in | 5016 | Keystone |
| 5 | TP3 TP5 TP10 TP18 TP20 | 5013 | Test point, orange, thru hole | 0.125 x 0.125 in | 5013 | Keystone |
| 4 | TP7-8 TP13 TP19 | 5011 | Test point, black, thru hole | 0.125 x 0.125 in | 5011 | Keystone |
| 2 | U1 U3 | PC357N4J000F | Photocoupler, 300-600% CTR, 3.75 kV isolation | MF4 | PC357N4J000F | Sharp |
| 1 | U2 | TPS23751PWP | IC, IEEE 802.3 AT PoE Interface & Green Mode DC-DC Controller | HTSSOP | TPS23751PWP | TI |
| 1 | U4 | TCMT1107 | IC, Photocoupler, 3750 VRMS, 80-160% CTR | MF4 | TCMT1107 | Vishay |
| 1 | U5 | TLV431A | IC, Shunt Regulator, 6V, 10mA, 1% | SOT23-5 | TLV431ACDBVR | TI |
| 2 | | | Shunt, black | 100-mil | 929950-00 | 3M |

Table 5. TPS23751EVM-104 Bill of Materials (continued)

| Count | REFDES | Value | Description | Size | Part Number | Supplier |
|-------|--------|-------|---------------------------------|------|-------------|----------|
| 1 | -- | | PCB, 3.5 in x 1.7 in x 0.062 in | | PWR104 | Any |

EVALUATION BOARD/KIT/MODULE (EVM) ADDITIONAL TERMS

Texas Instruments (TI) provides the enclosed Evaluation Board/Kit/Module (EVM) under the following conditions:

The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods.

Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. THE FOREGOING LIMITED WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE. EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

Please read the User's Guide and, specifically, the Warnings and Restrictions notice in the User's Guide prior to handling the product. This notice contains important safety information about temperatures and voltages. For additional information on TI's environmental and/or safety programs, please visit www.ti.com/esh or contact TI.

No license is granted under any patent right or other intellectual property right of TI covering or relating to any machine, process, or combination in which such TI products or services might be or are used. TI currently deals with a variety of customers for products, and therefore our arrangement with the user is not exclusive. TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein.

REGULATORY COMPLIANCE INFORMATION

As noted in the EVM User's Guide and/or EVM itself, this EVM and/or accompanying hardware may or may not be subject to the Federal Communications Commission (FCC) and Industry Canada (IC) rules.

For EVMs **not** subject to the above rules, this evaluation board/kit/module is intended for use for ENGINEERING DEVELOPMENT, DEMONSTRATION OR EVALUATION PURPOSES ONLY and is not considered by TI to be a finished end product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC or ICES-003 rules, which are designed to provide reasonable protection against radio frequency interference. Operation of the equipment may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

General Statement for EVMs including a radio

User Power/Frequency Use Obligations: This radio is intended for development/professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability of this EVM and its development application(s) must comply with local laws governing radio spectrum allocation and power limits for this evaluation module. It is the user's sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by Texas Instruments unless user has obtained appropriate experimental/development licenses from local regulatory authorities, which is responsibility of user including its acceptable authorization.

For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

For EVMs annotated as IC – INDUSTRY CANADA Compliant

This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

Concerning EVMs including radio transmitters

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concerning EVMs including detachable antennas

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l'autorité de l'utilisateur pour actionner l'équipement.

Concernant les EVMs avec appareils radio

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

【Important Notice for Users of this Product in Japan】

This development kit is NOT certified as Confirming to Technical Regulations of Radio Law of Japan

If you use this product in Japan, you are required by Radio Law of Japan to follow the instructions below with respect to this product:

1. Use this product in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use this product only after you obtained the license of Test Radio Station as provided in Radio Law of Japan with respect to this product, or
3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

Texas Instruments Japan Limited
(address) 24-1, Nishi-Shinjuku 6 chome, Shinjuku-ku, Tokyo, Japan

<http://www.tij.co.jp>

【ご使用にあたっての注】

本開発キットは技術基準適合証明を受けておりません。

本製品のご使用に際しては、電波法遵守のため、以下のいずれかの措置を取っていただく必要がありますのでご注意ください。

1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用いただく。
2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。

なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。

上記を遵守頂けない場合は、電波法の罰則が適用される可能性があることをご留意ください。

日本テキサス・インスツルメンツ株式会社

東京都新宿区西新宿 6 丁目 24 番 1 号

西新宿三井ビル

<http://www.tij.co.jp>

EVALUATION BOARD/KIT/MODULE (EVM) WARNINGS, RESTRICTIONS AND DISCLAIMERS

For Feasibility Evaluation Only, in Laboratory/Development Environments. Unless otherwise indicated, this EVM is not a finished electrical equipment and not intended for consumer use. It is intended solely for use for preliminary feasibility evaluation in laboratory/development environments by technically qualified electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems and subsystems. It should not be used as all or part of a finished end product.

Your Sole Responsibility and Risk. You acknowledge, represent and agree that:

1. You have unique knowledge concerning Federal, State and local regulatory requirements (including but not limited to Food and Drug Administration regulations, if applicable) which relate to your products and which relate to your use (and/or that of your employees, affiliates, contractors or designees) of the EVM for evaluation, testing and other purposes.
2. You have full and exclusive responsibility to assure the safety and compliance of your products with all such laws and other applicable regulatory requirements, and also to assure the safety of any activities to be conducted by you and/or your employees, affiliates, contractors or designees, using the EVM. Further, you are responsible to assure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.
3. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.
4. You will take care of proper disposal and recycling of the EVM's electronic components and packing materials.

Certain Instructions. It is important to operate this EVM within TI's recommended specifications and environmental considerations per the user guidelines. Exceeding the specified EVM ratings (including but not limited to input and output voltage, current, power, and environmental ranges) may cause property damage, personal injury or death. If there are questions concerning these ratings please contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, some circuit components may have case temperatures greater than 60°C as long as the input and output are maintained at a normal ambient operating temperature. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors which can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during normal operation, please be aware that these devices may be very warm to the touch. As with all electronic evaluation tools, only qualified personnel knowledgeable in electronic measurement and diagnostics normally found in development environments should use these EVMs.

Agreement to Defend, Indemnify and Hold Harmless. You agree to defend, indemnify and hold TI, its licensors and their representatives harmless from and against any and all claims, damages, losses, expenses, costs and liabilities (collectively, "Claims") arising out of or in connection with any use of the EVM that is not in accordance with the terms of the agreement. This obligation shall apply whether Claims arise under law of tort or contract or any other legal theory, and even if the EVM fails to perform as described or expected.

Safety-Critical or Life-Critical Applications. If you intend to evaluate the components for possible use in safety critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, such as devices which are classified as FDA Class III or similar classification, then you must specifically notify TI of such intent and enter into a separate Assurance and Indemnity Agreement.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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STANDARD TERMS FOR EVALUATION MODULES

1. *Delivery:* TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
 - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software
 - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
- 2 *Limited Warranty and Related Remedies/Disclaimers:*
 - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
 - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects with ten (10) business days after the defect has been detected.
 - 2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

WARNING

Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI's recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI's recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI's instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGRADATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

3.3 Japan

3.3.1 *Notice for EVMs delivered in Japan:* Please see http://www.tij.co.jp/lsts/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。

<https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-delivered-in-japan.html>

3.3.2 *Notice for Users of EVMs Considered "Radio Frequency Products" in Japan:* EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

【無線電波を送信する製品の開発キットをお使いになる際の注意事項】開発キットの中には技術基準適合証明を受けていないものがあります。技術適合証明を受けていないものご使用に際しては、電波法遵守のため、以下のいずれかの措置を取っていただく必要がありますのでご注意ください。

1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用いただく。
2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。

なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。

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東京都新宿区西新宿6丁目24番1号

西新宿三井ビル

3.3.3 *Notice for EVMs for Power Line Communication:* Please see http://www.tij.co.jp/lsts/ti_ja/general/eStore/notice_02.page
電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。<https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-for-power-line-communication.html>

3.4 European Union

3.4.1 *For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):*

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

4 *EVM Use Restrictions and Warnings:*

- 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
 - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
 - 4.3 *Safety-Related Warnings and Restrictions:*
 - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
 - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
 - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
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